

MATE-N-LOK | Micro MATE-N-LOK

TE Internal #: 3-794680-6 PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 3 mm [.118 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Power, Micro MATE-N-LOK

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 6

Number of Rows: 2

Centerline (Pitch): 3 mm [.118 in]

PCB Mount Orientation: Vertical

Features

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Product Type Features

Mixed & Hybrid Header	No	
Connector Shape	Rectangular	
Connector System	Wire-to-Board	
Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Number of Power Positions	6	
Number of Columns	3	
Number of Loaded Positions	6	
Connector Contact Load Condition	Fully Loaded	
Number of Positions	6	
Number of Rows	2	

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PCB Mount Orientation	Vertical	
Electrical Characteristics		
Operating Voltage	250 VAC	
Body Features		
PCB Retention Feature Material	Phosphor Bronze	
PCB Retention Feature Plating Material	Tin	
Primary Product Color	Black	
Contact Features		
Contact Mating Area Length	4.15 mm[.163 in]	
Contact Size	.64mm	
Mating Square Post Dimension	.64 mm[.025 in]	
PCB Contact Termination Area Plating Material Thickness	2.54 – 7.62 μm[100 – 300 μin]	
Contact Layout	Matrix	
Contact Underplating Material Thickness	1.27 – 2.54 μm[50 – 100 μin]	
Contact Mating Area Plating Material Thickness	2.54 – 7.62 μm[100 – 300 μin]	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	Square	
Contact Mating Area Plating Material Finish	Matte	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Brass	
Contact Mating Area Plating Material	Tin	
Contact Type	Tab	
Contact Current Rating (Max)	5 A	
Termination Features		
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Post & Tail Length	3.18 mm[.125 in]	
Termination Method to PCB	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment Type	Polarization	
Mating Retention	With	
Panel Mount Feature	Without	

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PCB Mount Retention Type	Hold-Down, Retention Bump	
Mating Retention Type	Locking Tab	
Connector Mounting Type	Board Mount	
Mating Alignment	With	
PCB Mount Alignment	Without	
PCB Mount Retention	With	
Housing Features		
Mating Entry Location	Тор	
Housing Material	High Temperature Nylon	
Centerline (Pitch)	3 mm[.118 in]	
Dimensions		
Connector Length	13 mm[.512 in]	
Connector Height	9.24 mm[.364 in]	
Connector Width	8.67 mm[.341 in]	
PCB Thickness (Recommended)	1.57 mm[.062 in]	
Row-to-Row Spacing	3 mm[.118 in]	
Usage Conditions		

Operating Temperature (Max)	105 °C[221 °F]	
Operating Temperature Range	-40 – 105 °C[-40 – 221 °F]	
Operation/Application		
Circuit Application	Power	
Industry Standards		
UL Rating	Recognized	
Glow Wire Rating	GWT 750°C (Without Flame)	
Compatible With Agency/Standards Products	CNR, USR	
Compatible With Approved Standards Products	UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	286	
Packaging Method	Tray	

Product Compliance

For compliance documentation, visit the product page on TE.com>

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EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-

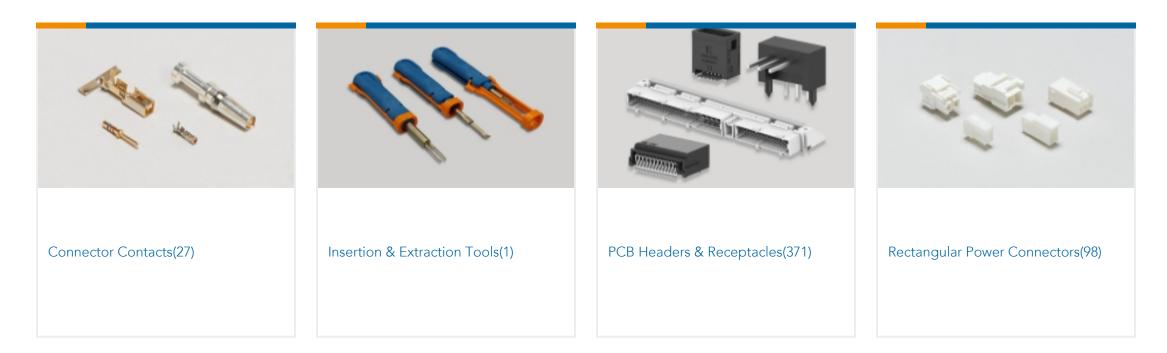
Compatible Parts



Also in the Series | Micro MATE-N-LOK

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 3 mm [.118 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Power, Micro MATE-N-LOK





Customers Also Bought



IDC LOW PRO HDR 40P VERT BLUE	8P,2MM,BRK HDR,DRVT,SMD,0.1AU, TR W/CAP	CRGP 2512 100K 1%	RP 1E 0.1W 165K 0.1% 25PPM 5K RL
TE Part #1-1879125-2 RN 0402 54R9 0.1% 10PPM 5K RL			

Documents

Product Drawings 06P MICRO MNL ASSY,VRT,THRU LF

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_3-794680-6_G.2d_dxf.zip

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English

Customer View Model ENG_CVM_CVM_3-794680-6_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_3-794680-6_G.3d_stp.zip

English

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Datasheets & Catalog Pages

SOFT_SHELL_PIN_AND_SOCKET_CONNECTORS_CATALOG

English

MICRO MATE-N-LOK CONNECTOR SYSTEM

English

Product Specifications

Application Specification

English

Agency Approvals VDE Certificate

English